# □ MN101D06F , MN101D06G , MN101D06H

VTR Servo

Туре	MN101D06F	MN101D06G	MN101D06H		
ROM (×8-bit)	96 K	128 K	160 K		
RAM (×8-bit)	3 K	4 K	5 K		
Package	QFP100-P-1818B *Lead-free				
Minimum Instruction Execution Time	When sub-clock operated 71.5 µs				
Interrupts	<ul> <li>• RESET • Runaway • External 0, 1, 2, 3, 4/key input (P50 to 54) • Timer 0 • Timer 1 • Timer 2 • Timer 3</li> <li>• Timer 4 • Timer 6 • Capstan FG • Control • HSW • Cylinder FG • Servo VSYNC • Synchronous output</li> <li>• OSD • XDS • Serial 0 • Serial 1 • Serial 2 • A/D (common with PWM 4 reference frequency)</li> <li>• OSDVSYNC</li> </ul>				
Timer Counter	Clock source ······ 1/2	x. 2 s or max. 36 h at cascade-connectin 2, 1/4, 1/8, 1/16 of system clock frequen 512 of XI oscillation clock or OSC oscil erflow of timer counter 0	cy; overflow of timer counter 6;		
	Timer counter 1: 16-bit × 1 (timer function, linear timer counter function) Clock source				
	Timer counter 2: 16-bit × 1 (timer function, input capture (DCTL specified edge), duty judgment of DCTL signal) Clock source				
		ndexing, generation of remote control or 2, 1/4, 1/8, 1/16 of system clock frequence erflow of timer counter 3			
	Timer counter 4: 16-bit × 1 (timer function, event count [P15 input], generation of serial transmission clock) Clock source				
	Clock source ······sys Watchdog interrupt source · 1/2	og, stable oscillation waiting function) stem clock <sup>16</sup> , 1/2 <sup>19</sup> of timer counter 5 frequency er 256 counts by timer counter 5 (2 <sup>18</sup> co			
	1/4	nction [max. 2 s]) 512 of OSC oscillation clock frequency; 4, 1/8, 1/64, 1/128 of system clock frequ 2 <sup>13</sup> , 1/2 <sup>14</sup> , 1/2 <sup>15</sup> overflow of timer counter	iency		
	Timer counter 7: 8-bit × 1 (timer func Clock source	, 1/8, 1/16, 1/32 of system clock frequen	ncy; external clock input		
Serial Interface	Synchronous type clock source · 1/4 2-c	start-stop synchronous type) (transfer di 4, 1/8, 1/16, 1/32, 1/64, 1/128, 1/256 of livision timer 4 output; SBT0 pin input livision of above clock; 2-division timer	system clock frequency;		

Serial Interface (Continue)	Serial 1: 8-bit × 1 (synchronous type/remote control transmission/simple remote control receive) (transfer direction of MSB/LSB selectable, start condition function)				
	Clock source 1/8, 1/	/16, 1/32, 1/64, 1/128, 1/256 of system clock frequency;			
	2-divi	sion timer 4 output; SBT1 pin input			
	Remote control clock 2-divi	sion timer 4 output			
	Serial 2: 8-bit × 1 (I <sup>2</sup> C) (master transmi	ssion/reception, slave transmission/reception)			
	Clock source 1/144	to 1/252 of system clock; SCK pin input			
OSD	OSD mode:Accommodation with menu or super impose display				
	Applicable broadcasting system : NTSC, PAL, PAL-M, PAL-N				
	Screen configuration	: 24 characters $\times$ 2n rows (n = 1 to 6)			
	Character type	: max. 512 character types (variable)			
	Character size	: $12 \times 18$ dots (Vertical direction: 1 dot for 2H at $\times 1$ setting.)			
	Enlarged characters	: each $\times$ 2, $\times$ 3 or $\times$ 4 settings in horizontal and vertical			
	Character interpolation Line background color	: none : 8-hue settable (settable in the row unit at menu display)			
	Line background intensity	: 8 gradations settable in the row unit			
	Screen background color	: 8-hue settable (at output of composite video signal)			
	Character color	: white			
	Character intensity	: 8 gradations settable in the row unit			
	Frame function	: 1-dot frame in 4 or 8 directions			
	Frame intensity	: 4 gradations settable in the row unit			
	Box shade function	: settable in the character unit (at output of composite video signal with 129 or more characters (character types))			
	Blinking	: none (covered by software)			
	Inverted character	: settable in the character unit			
	Halftone	: settable in the row unit in 2 intensity gradations (at output of external synchronous composite video signal)			
	CCD mode: Supports Closed Caption				
	Screen configuration	: 32 characters × 16 rows			
	Character type	: max. 128 character types (variable)			
	Character size	: $12 \times 26$ dots (Vertical direction: 1 dot for 1H, including 8 dots in the underlined area)			
	Enlarged characters	: none			
	Character interpolation	: none			
	Line background color	: 8-hue settable			
	Line background intensity	: 8 gradations settable in the screen unit (at output of composite video signal)			
	Screen background color	: 8-hue settable (at output of composite video signal)			
	Character color	: 8 colors (at RGB output)			
	Character intensity	: White (at output of composite video signal) : 8 gradations settable in the screen unit			
	Frame function	: o gradations settable in the screen unit			
	Box shade function	: none			
	Inverted character	: none			
	Halftone	: settable in the row unit in 2 intensity gradations			
		(at output of external synchronous composite video signal)			
	Others	: Underline, italic, blinking function and scroll			
	Input	: composite video signal input (output level: 1 V[p-p] / 2 V[p-p])			
	Clamp method	: sync chip clamp, clamp level in 4 levels			
	Output	: composite video output			
		: digital output (6 pins)			
	Measure against image fluctuation	: built-in AFC circuit			
	Dot clock	: 1/2 of OSC oscillation clock (automatic phase adjustment)			

See the next page for electrical characteristics, pin assignment and support tool.

Panasonic

XDS		Built-in U.S. closed caption data slicer (optional 2 line data can be extracted.)		
ROM Correct	tion	Correcting address designation: up to 3 addresses possible Correction method: correction program being saved in internal RAM		
I/O Pins	I/O	75         • Common use: 75 ports 0, 1, 2, 4, 5, 6, 7, A, B (by bit)		
	Input	2 • Common use: 2		
A/D Inputs		$8$ -bit $\times$ 13-ch. (without S/H)		
PWM		13-bit × 2-ch. (at repetition cycle 572 μs, 14.32 MHz), 10-bit × 2-ch. (at repetition cycle 71.5 μs, 14.32 MHz), 8-bit × 1-ch. (at repetition cycle 35.7 μs, 14.32 MHz)		
ICR		18-bit × 6-ch.		
OCR		16-bit × 7-ch., 8-bit × 1-ch.		
Special Ports	5	Buzzer output; 3-state output (PTO) VLP pin; synchronous output: 7; 3-state synchronous output: 4; remote control receive; CTL amp; built-in FG amp; output of 1/2 OSC oscillation clock (2 V[p-p]); output of 1/4 OSC oscillation clock (1 V[p-p])		
Notes		VISS/VASS detection function		

## Electrical Characteristics

Supply current

Parameter	Symbol	Condition	Limit			Unit		
	Symbol	Condition		typ	max	Unit		
	IDD1	14.32 MHz operation without load, $VDD = 5 V$		60	100	mA		
Operating supply current	IDD2	1/1024 of 14.32 MHz operation without load, VDD = 3.0 V		2	5	mA		
Operating supply current	IDD3	Stop of 14.32 MHz oscillation, VDD = 2.7 V		50	100	μA		
	1005	32 kHz oscillation operation without load						
Supply current at STOP	IDSP	Stop of oscillation without load, VDD = 5 V			20	μA		
	IDHT0	14.32 MHz oscillation without load, VDD = 5 V		5	15	mA		
Supply current at HALT	IDHT1	Stop of 14.32 MHz oscillation, VDD = 2.7 V		5	5	5	20	0
	ווחתו	32 kHz oscillation operation without load			20	μA		

 $(Ta = 25^{\circ}C \pm 2^{\circ}C, VSS = 0 V)$ 

#### A/D Converter Performance

Parameter	er Symbol Condi	Condition	Limit			Unit
Falameter Symbol	condition	min	typ	max		
Conversion relative error	ΔNLAD				± 3	LSB
A/D Conversion Time	tAD	fosc = 14.32 MHz		8		μs
Analog Input Voltage					5	V

 $(Ta=25^{\circ}C\pm2^{\circ}C$  , VDD=5.0~V , VSS=0~V)



### Support Tool

In-circuit Emulator	PX-ICE101C / D + PX-PRB101D06-QFP100-P-1818B-M		
Flash Memory Built-in Type	Туре	MN101DF06Z	
	ROM (× 8-bit)	224 К	
	RAM (× 8-bit)	6 K	
	Minimum instruction execution time	0.1397 µs (at 4.0 V to 5.5 V, 14.32 MHz)	
		71.5 $\mu s$ (at 3.0 V to 5.5 V, fixed to 14.32 MHz internal division)	
	Package	QFP100-P-1818B *Lead-free	

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